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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/791,751	03/04/2004	Kazuo Tomita	402992	5267
23548	7590	02/13/2006	EXAMINER	
LEYDIG VOIT & MAYER, LTD 700 THIRTEENTH ST. NW SUITE 300 WASHINGTON, DC 20005-3960				CHU, CHRIS C
		ART UNIT		PAPER NUMBER
		2815		

DATE MAILED: 02/13/2006

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.	Applicant(s)	
10/791,751	TOMITA ET AL.	
Examiner	Art Unit	
Chris C. Chu	2815	

-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --
Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

1) Responsive to communication(s) filed on 27 December 2005.
2a) This action is FINAL. 2b) This action is non-final.
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

4) Claim(s) 9 and 10 is/are pending in the application.
4a) Of the above claim(s) _____ is/are withdrawn from consideration.
5) Claim(s) _____ is/are allowed.
6) Claim(s) 9 and 10 is/are rejected.
7) Claim(s) _____ is/are objected to.
8) Claim(s) _____ are subject to restriction and/or election requirement.

Application Papers

9) The specification is objected to by the Examiner.
10) The drawing(s) filed on _____ is/are: a) accepted or b) objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
11) The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

12) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
a) All b) Some * c) None of:
1. Certified copies of the priority documents have been received.
2. Certified copies of the priority documents have been received in Application No. _____.
3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

1) Notice of References Cited (PTO-892)
2) Notice of Draftsperson's Patent Drawing Review (PTO-948)
3) Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date _____.
4) Interview Summary (PTO-413)
Paper No(s)/Mail Date. _____.
5) Notice of Informal Patent Application (PTO-152)
6) Other: _____.

DETAILED ACTION

Request for Continued Examination

1. A request for continued examination (RCE) under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after final rejection. Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, the finality of the previous Office action has been withdrawn pursuant to 37 CFR 1.114. Applicant's submission filed on December 27, 2005 has been entered. An action on the RCE follows.

Response to Amendment

2. Applicant's amendment filed on December 27, 2005 has been received and entered in the case.

Claim Rejections - 35 USC § 103

3. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

4. Claims 9 and 10 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lui et al. (U. S. Pat. No. 6,582,974) in view of Yang et al. (U. S. Pat. No. 6,468,894).

Regarding claim 9, Lui et al. discloses in e.g., Fig. 6 an interconnecting structure (the interconnecting wiring in Fig. 6) comprising:

- first wirings (12) supported by a substrate (10);
- a low-k dielectric film (16 and 20 (16a and 20a'); column 7, lines 55 – 67) on the first wirings, the low-k dielectric film having a dielectric constant not exceeding 3 (k is approximately between about 2.0 to about 2.5 – column 7, lines 55 – 59);
- a cap film (22a') on the low-dielectric film (16a and 20a'; see e.g., Fig. 6);
- vias (the vias between the elements 32a and 12; see e.g., Fig. 6) in the low-k dielectric film (16a and 20a'), the vias being contacting to the first wiring (12);
- second wirings (32a; column 11, lines 14 – 26) partially within the low-k dielectric film (16a and 20a') and connected to the vias (see Fig. 6), the second wiring (32a) being partially within the cap film (22a') and having a surface coplanar with a surface of the cap film (22a'; see Fig. 6).

However, Lui et al. does not disclose dummy vias. Yang et al. teaches in e.g., Fig. 7 dummy vias (32, 34 and 36; column 5, line 52) on the periphery of an isolated via of vias (30; see e.g., Fig. 7 and column 5, lines 26 – 28). It would have been obvious to one of ordinary skill in the art at the time when the invention was made to apply the dummy vias of Yang et al. in to the structure of Lui et al. as taught by Yang et al. to improve the quality of the metal interconnect portion of the semiconductor device (column 5, lines 53 and 54).

Regarding claim 10, since Lui et al. (column 1, lines 11 – 13) and Yang et al. (column 2, lines 34 – 39) uses a damascene process to form the interconnect structures, Lui et al. and Yang

et al. fully meet the following limitation “all of the first wirings, the vias, the second wirings, and the dummy vias have a damascene structure”.

Response to Arguments

5. Applicant's arguments with respect to claim 9 have been considered but are moot in view of the new ground(s) of rejection.

Conclusion

6. The prior art made of record and not relied upon is considered pertinent to applicant's disclosure. Huang et al. discloses a damascene structure.

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Chris C. Chu whose telephone number is 571-272-1724. The examiner can normally be reached on 11:30 - 8:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Kenneth Parker can be reached on 571-272-2298. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

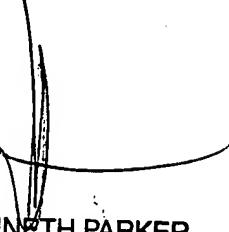
Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>.

Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Chris C. Chu
Examiner
Art Unit 2815

c.c.

Tuesday, January 31, 2006



KENNETH PARKER
SUPERVISORY PATENT EXAMINER